

Small Signal Schottky Diode



Features

- Epoxy meets UL-94 V-0 flammability rating and halogen free
- Moisture Sensitivity Level 1
- Low Forward Voltage Schottky Rectifier
- V_{RRM} 70V
- I_{FAV} 70mA
- Part no. with suffix "Q" means AEC-Q101 qualified

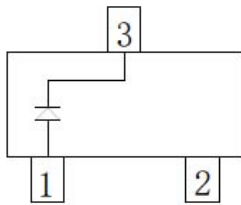
Applications

- For Transient and ESD Protection
- Automotive

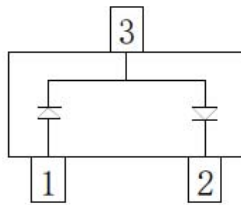
Mechanical Data

- **Case:** SOT-23
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102

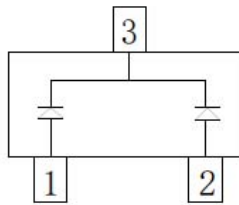
SOT-23



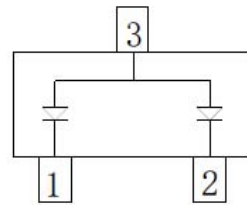
BAS70Q
Marking:73



BAS70-04Q
Marking:74



BAS70-05Q
Marking:75



BAS70-06Q
Marking:76

■ Maximum Ratings ($T_a=25^{\circ}\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	CONDITIONS	VALUE
Repetitive Peak Reverse Voltage	V_{RRM}	V		70
Average Forward Current	I_{FAV}	mA		70
Peak Forward Surge Current	I_{FSM}	A	$t=8.3\text{ms}$	3
Power Dissipation	P_{tot}	mW		250
Thermal Resistance Junction to Ambient	R_{thJA}	K/W		500
Junction Temperature	T_j	$^{\circ}\text{C}$		-55 to +150
Storage Temperature Range	T_{stg}	$^{\circ}\text{C}$		-55 to +150



BAS70Q&BAS70-04Q&BAS70-05Q&BAS70-06Q

■ Electrical Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	CONDITIONS	MIN	MAX
Forward Voltage	V _F	V	I _F =1mA		0.41
			I _F =15mA		1
Reverse Current	I _R	μA	V _R =50V		0.2
Breakdown Voltage	V _{BR}	V	I _R =10μA	70	
Junction Capacitance	C _J	pF	V _R =0 V, f =1MHZ		4
Reverse Recovery Time	t _{rr}	ns	I _F =I _R =10mA, I _{rr} =1mA, R _L =100Ω		5

■ Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
BAS70Q/ BAS70-04Q/ BAS70-05Q/ BAS70-06Q	F2	Approximate 0.01	3000	30000	120000	7" reel



■ Characteristics (Typical)

Fig.1: P_D-T_A

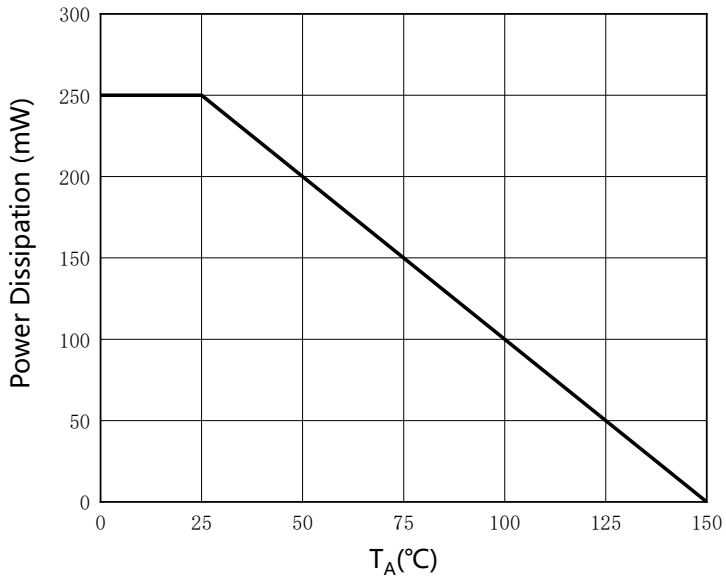


Fig.2: Capacitance Characteristics

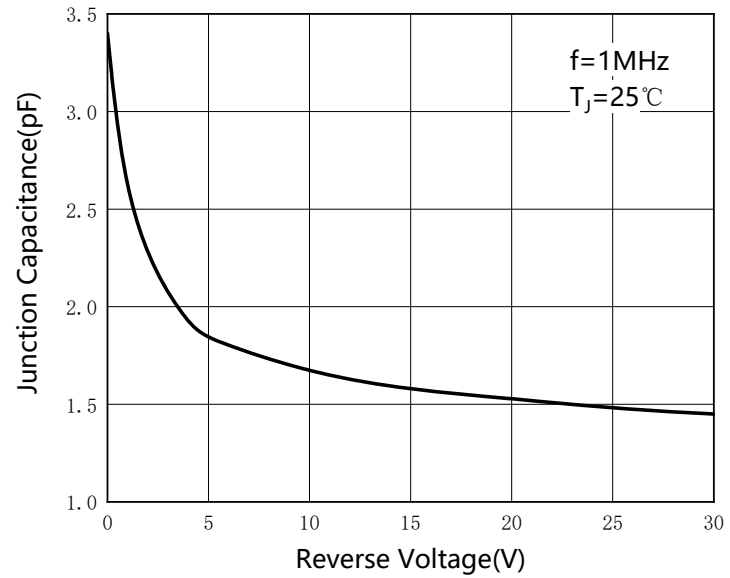


Fig.3: Forward Characteristics

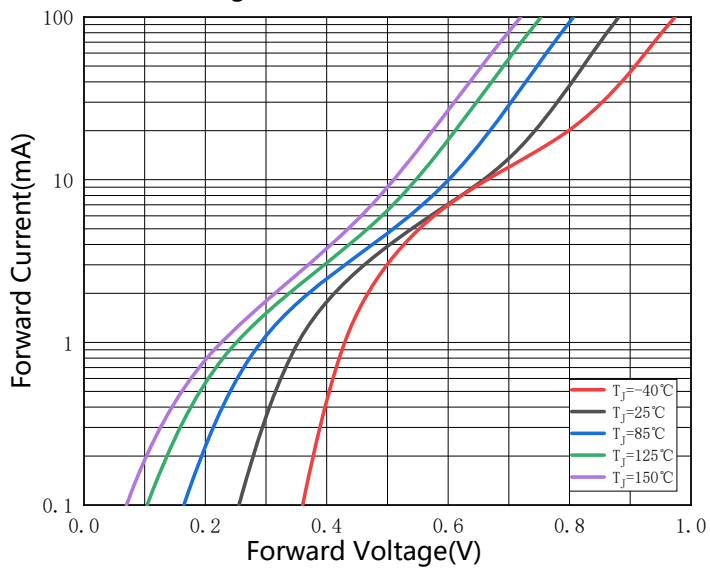
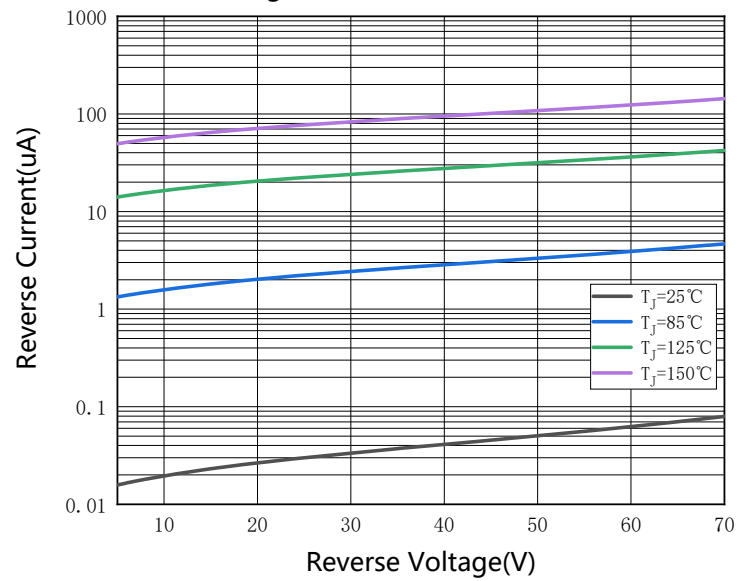


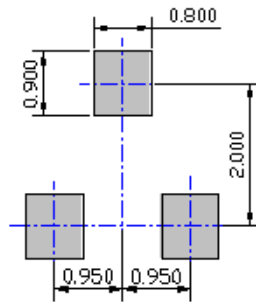
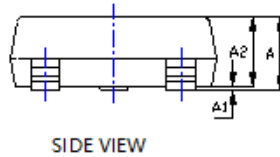
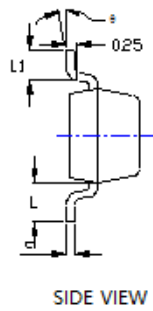
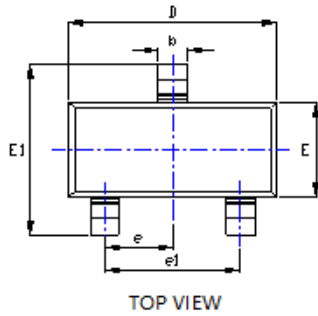
Fig.4: Reverse Characteristics





BAS70Q&BAS70-04Q&BAS70-05Q&BAS70-06Q

■ Outline Dimensions



UNIT: mm

SUGGESTED SOLDER PAD LAYOUT

SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.035	0.045	0.900	1.150
A1	0.000	0.004	0.000	0.100
A2	0.035	0.041	0.900	1.050
b	0.012	0.020	0.300	0.500
c	0.004	0.008	0.100	0.200
D	0.110	0.118	2.800	3.000
E	0.047	0.055	1.200	1.400
E1	0.089	0.100	2.250	2.550
e	0.037TYP		0.950TYP	
e1	0.071	0.079	1.800	2.000
L	0.022REF		0.550REF	
L1	0.012	0.020	0.300	0.500
θ	0°	8°	0°	8°

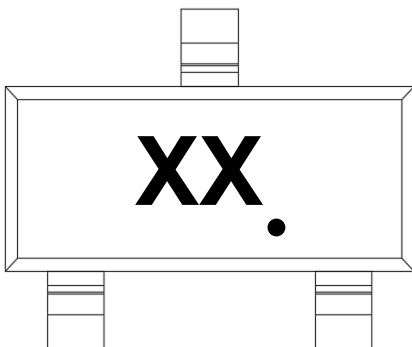
NOTE:

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.

2. TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.

3. THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.

■ Marking Information



PN	Marking Code
BAS70Q	73.
BAS70- 04Q	74.
BAS70-05Q	75.
BAS70- 06Q	76.

Note:

1. All marking is at middle of the product body
2. All marking is in laser marking
3. XX. is Marking Code
4. Body color: Black



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